

Title (en)  
TWO-PHASE STAINLESS STEEL AND PRODUCTION METHOD THEREFOR

Title (de)  
ZWEIPHASIGER EDELSTAHL UND HERSTELLUNGSVERFAHREN DAFÜR

Title (fr)  
ACIER INOXYDABLE À DEUX PHASES ET SON PROCÉDÉ DE PRODUCTION

Publication  
**EP 3211107 A1 20170830 (EN)**

Application  
**EP 15852926 A 20151023**

Priority  
• JP 2014217632 A 20141024  
• JP 2015079962 W 20151023

Abstract (en)  
A duplex stainless steel is provided that has a chemical composition comprising, by mass%, C: 0.03% or less, Si: 1.0% or less, Mn: 1.0% or less, P: 0.04% or less, S: 0.01% or less, Cu: 0.1 to 1.0%, Ni: 5.0 to 7.5%, Cr: 22.0 to 26.0%, W: 6.0 to 12.0%, N: 0.20 to 0.32%, Mo: 0.01% or less, and a balance: Fe and impurities, in which a metal micro-structure contains, by area ratio, 0.40 to 0.60 of an  $\alpha$ -phase, with a balance being a  $\beta$ -phase and 0.01 or less of other phases.

IPC 8 full level  
**C22C 38/42** (2006.01); **C21D 6/00** (2006.01); **C21D 8/00** (2006.01); **C21D 8/02** (2006.01); **C22C 38/00** (2006.01); **C22C 38/02** (2006.01); **C22C 38/04** (2006.01); **C22C 38/44** (2006.01)

CPC (source: EP US)  
**C21D 6/004** (2013.01 - EP US); **C21D 6/005** (2013.01 - US); **C21D 6/008** (2013.01 - US); **C21D 8/005** (2013.01 - EP US); **C21D 8/0226** (2013.01 - EP US); **C21D 8/0263** (2013.01 - EP US); **C22C 30/02** (2013.01 - US); **C22C 38/00** (2013.01 - EP US); **C22C 38/001** (2013.01 - EP US); **C22C 38/002** (2013.01 - US); **C22C 38/02** (2013.01 - EP US); **C22C 38/04** (2013.01 - EP US); **C22C 38/42** (2013.01 - EP US); **C22C 38/44** (2013.01 - EP US); **C21D 8/0205** (2013.01 - EP US); **C21D 8/0247** (2013.01 - EP US); **C21D 2211/001** (2013.01 - EP US); **C21D 2211/004** (2013.01 - EP US); **C21D 2211/005** (2013.01 - EP US)

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DOCDB simple family (publication)  
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